

PROGRAMMABLE TRANSIENT VOLTAGE SUPPRESSOR FOR SLIC PROTECTION

FEATURES

- DUAL PROGRAMMABLE TRANSIENT SUPPRESSOR.
- WIDE NEGATIVE FIRING VOLTAGE RANGE:
 $V_{MGL} = -80 \text{ V max}$
- HOLDING CURRENT = 150 mA.
- LOW GATE TRIGGERING CURRENT:
 $I_{GT} = 15 \text{ mA max.}$
- PEAK PULSE CURRENT:
 $I_{PP} = 30 \text{ A, } 10/1000 \mu\text{s}$
- AVAILABLE IN SO 8 AND DIP 8.

DESCRIPTION

This device has been especially designed to protect subscriber line card interfaces (SLIC) against transient overvoltages.

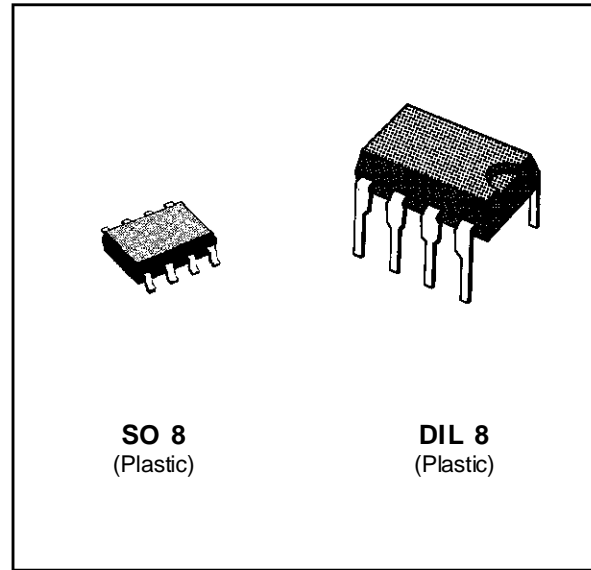
Positive overloads are clipped with two diodes. When negative surges are suppressed by two protection thyristors, the breakdown voltage of which is referenced to the -Vbat.

This component presents a very low gate triggering current (I_{GT}) in order to reduce the current consumption on PC board during the firing phase .

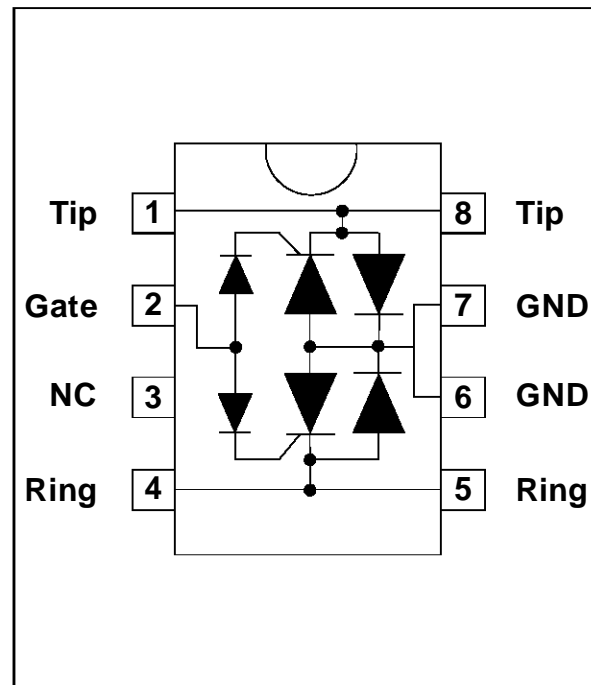
A particular attention has been given to the internal wire bonding . A "4-points configuration" ensures a reliable protection, eliminating the overvoltage introduced by the parasitic inductances of the wiring (Ldi/dt) especially for very fast transients.

IN ACCORDANCE WITH FOLLOWING STANDARDS :

CCITT K17 - K20	{	10/700 μs	1.5 kV
		5/310 μs	38 A
VDE 0433	{	10/700 μs	2 kV
		5/200 μs	50 A
CNET	{	0.5/700 μs	1.5 kV
		0.2/310 μs	38 A



SCHEMATIC DIAGRAM



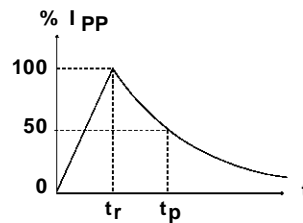
LCP1511 / LCP1512

ABSOLUTE RATINGS (limiting values) (-40°C ≤ Tamb ≤ +85°C)

Symbol	Parameter		Value	Unit
I _{PP}	Peak pulse current see note 1.	10/1000 μs 5/320 μs 2/10 μs	30 40 90	A
I _{TSM}	Non repetitive surge peak on-state current f = 50 Hz	t _p = 10 ms t _p = 1 s	5 3.5	A
I _{GSM}	Maximum gate current (half sine wave 10 ms)		2	A
V _{MLG} V _{MGL}	Maximum Voltage LINE/GND Maximum Voltage GATE/LINE		- 100 - 80	V
T _{stg} T _j	Storage and operating junction temperature range		- 55 to + 150 150	°C °C

Note 1: Pulse waveform

10/1000 μs	t _r = 10 μs	t _p = 1000 μs
5/320 μs	t _r = 5 μs	t _p = 320 μs
2/10 μs	t _r = 2 μs,	t _p = 10 μs

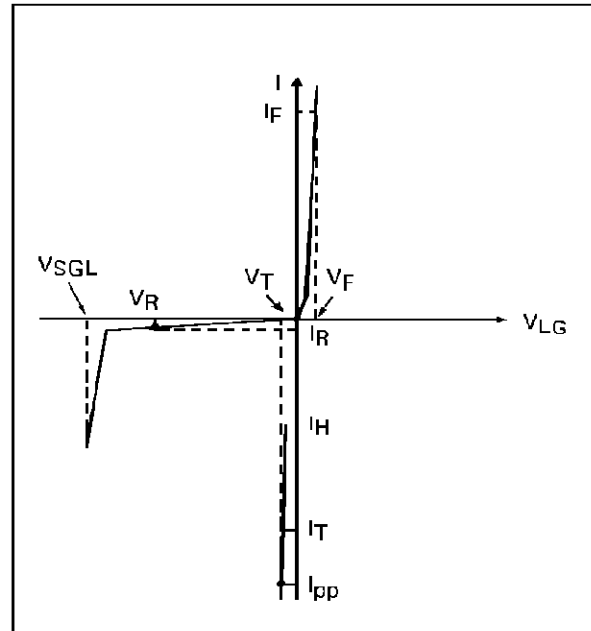


THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
R _{th(j-a)}	Junction-to-ambient	DIL 8 SO 8	125 171	°C/W °C/W

ELECTRICAL CHARACTERISTICS

Symbol	Parameter
I_{GT}	Gate Trigger Current
I_H	Holding Current
I_R	Reverse Leakage Current LINE/GND
I_{RG}	Reverse Leakage Current GATE/LINE
V_R	Reverse Voltage LINE/GND
V_F	Forward Voltage LINE/GND
V_{GT}	Gate Trigger Voltage
V_{FP}	Peak Forward Voltage LINE/GND
V_{SGL}	Dynamic Switching Voltage GND/LINE
V_{gate}	GATE/GND Voltage
V_{LG}	LINE/GND Voltage
dv/dt	Critical Rate of rise of off State Voltage
V_T	On State Voltage
C_{off}	Off State Capacitance LINE/GND



PARAMETERS RELATED TO THE DIODE LINE/GND

Symbol	Test Conditions	Max.	Unit
V_F	Square pulse, $t_p = 500 \mu s$, $I_F = 5 A$	3	V
V_{FP}	$I_{pp} = 30 A$, $10/1000 \mu s$.	15	V

PARAMETERS RELATED TO PROTECTION THYRISTOR

Symbol	Tests Conditions	Min.	Max.	Unit
I_{GT}	$V_{GND/LINE} = -48 V$	0.2	15	mA
I_H	$V_{GATE} = -48 V$ Note 2.	150		mA
V_{GT}	at I_{GT}		2.5	V
I_{RG}	$T_c = 25^\circ C$ $V_{RG} = -75 V$ $T_c = 70^\circ C$ $V_{RG} = -75 V$		5 50	μA μA
V_{SGL}	$V_{GATE} = -48 V$ Note 2.		- 63	V
V_T	Square pulse, $T_p = 500 \mu s$, $I_T = 0.5 A$ Square pulse, $T_p = 500 \mu s$, $I_T = 3 A$		3 4	V V

PARAMETERS RELATIVE TO DIODE AND PROTECTION THYRISTOR

Symbol	Tests Conditions	Min.	Max.	Unit
I_R	$T_c = 25^\circ C$ $-1 < V_{GL} < -V_{bat}$ $V_R = -85 V$ $T_c = 70^\circ C$ $-1 < V_{GL} < -V_{bat}$ $V_R = -85 V$		5 50	μA μA
C_{off}	$V_R = -3 V$ $F < 1 MHz$ $V_R = -48 V$ $F < 1 MHz$		100 50	pF pF

All Parameters Tested at $25^\circ C$ except when indicated.

Note 2 : See test circuit for I_H and V_{SGL} .

APPLICATION NOTE

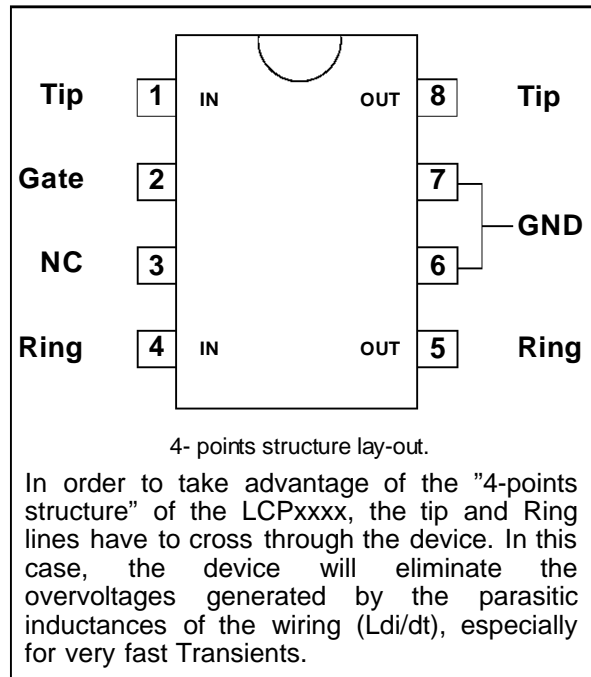
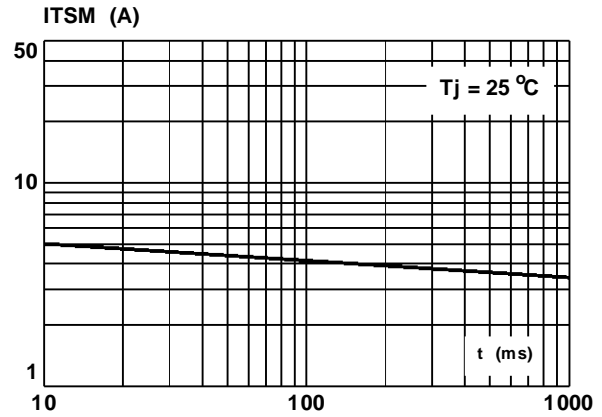
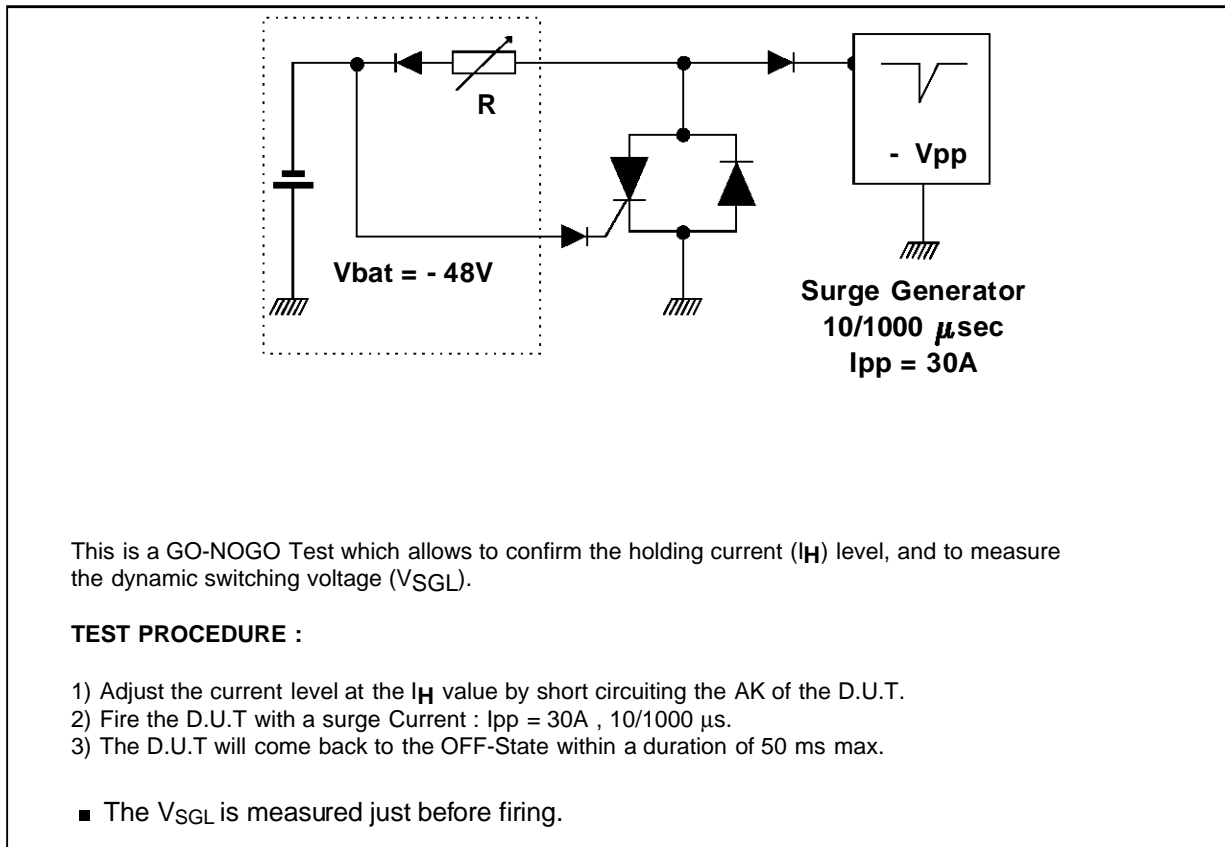


Figure 1 : Non repetitive surge peak on-state current. (with sinusoidal pulse : $F = 50\text{Hz}$)

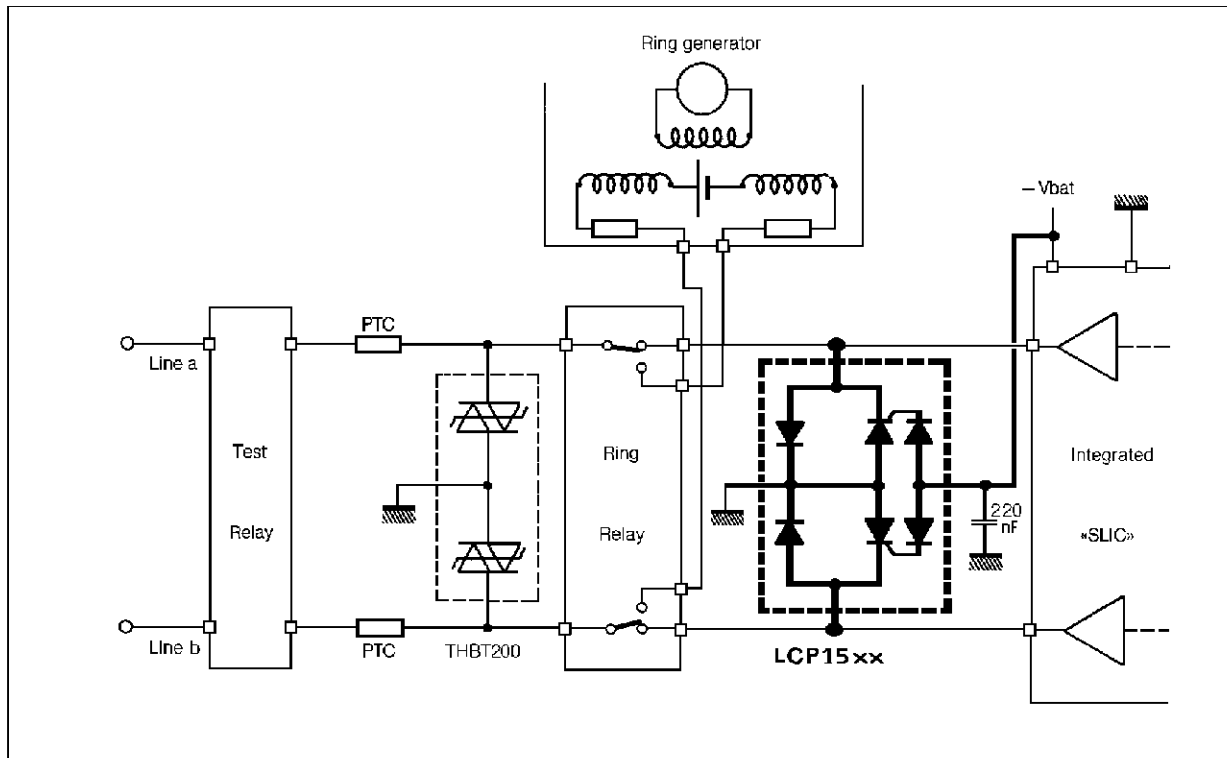


TEST CIRCUIT FOR I_H AND V_{SGL} PARAMETERS

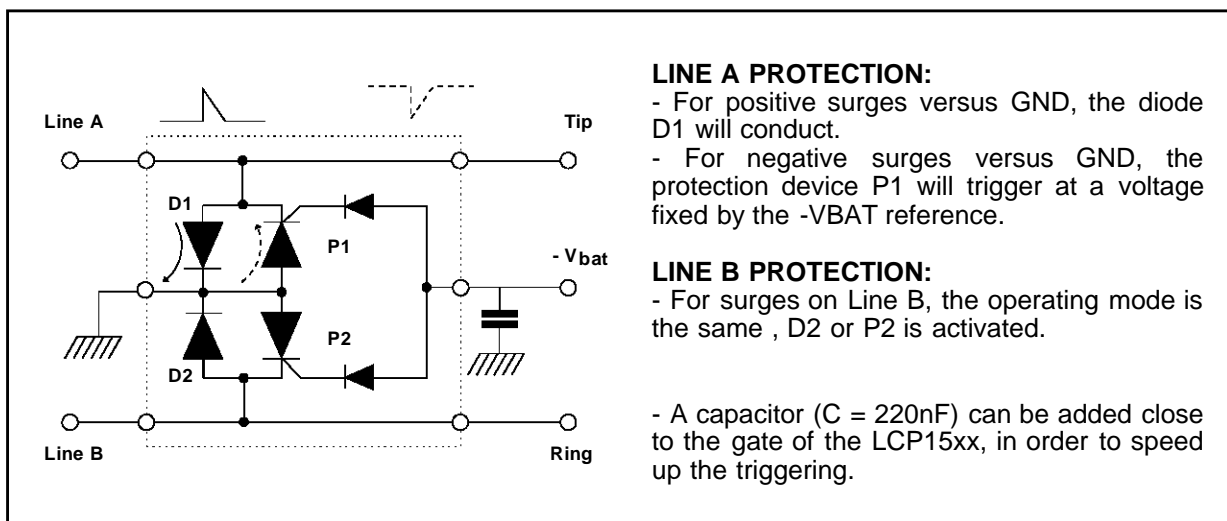


APPLICATION CIRCUIT

Typical slic protection concept

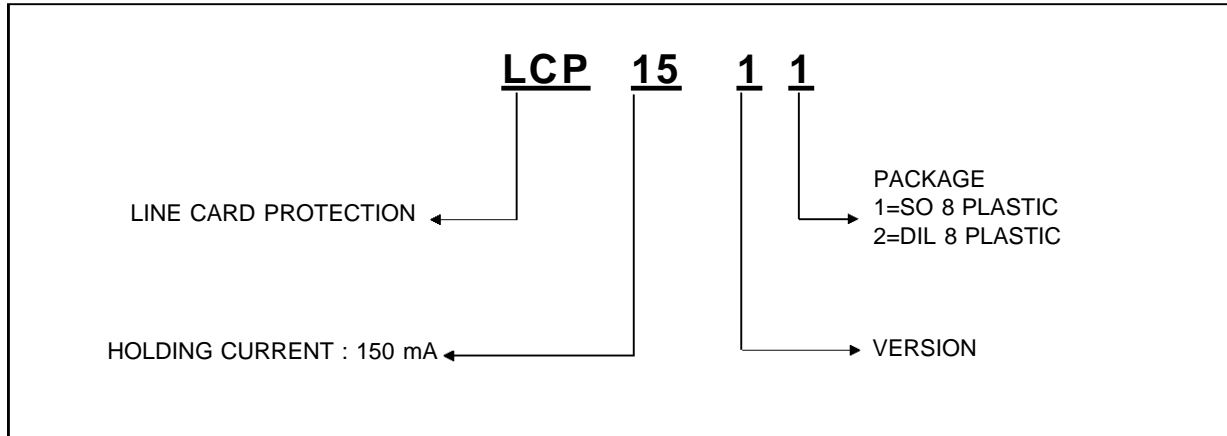


FUNCTIONAL DESCRIPTION



LCP1511 / LCP1512

ORDER CODE



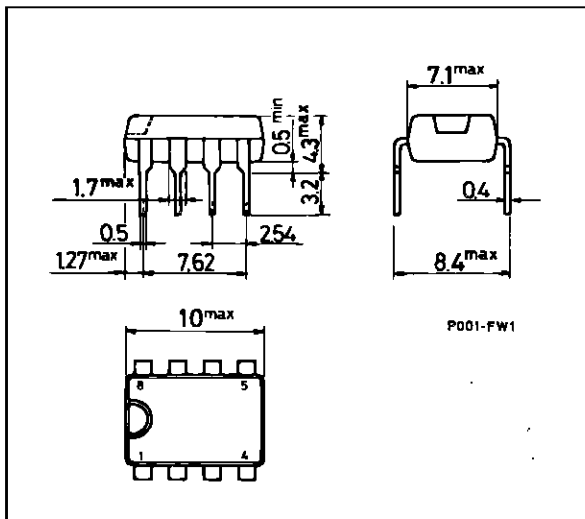
MARKING

Package	Type	Marking
SO8	LCP1511	CP1511
DIL8	LCP1512	CP1512

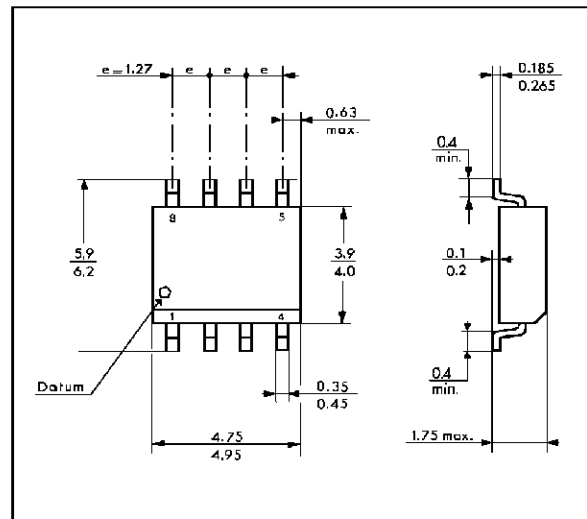
Packaging : Products supplied in antistatic tubes.

PACKAGE MECHANICAL DATA (in millimeters)

DIL 8 Plastic

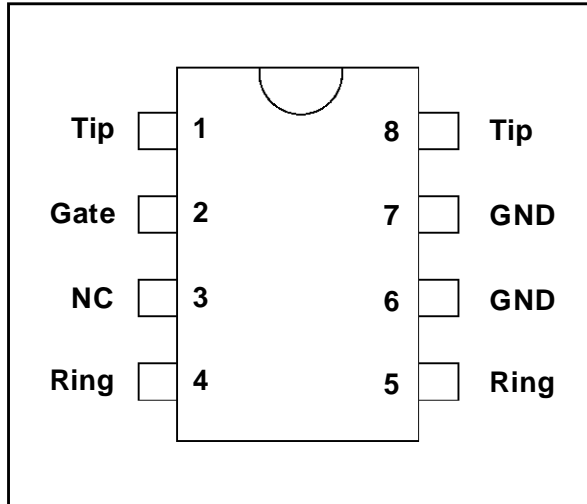


SO 8 Plastic

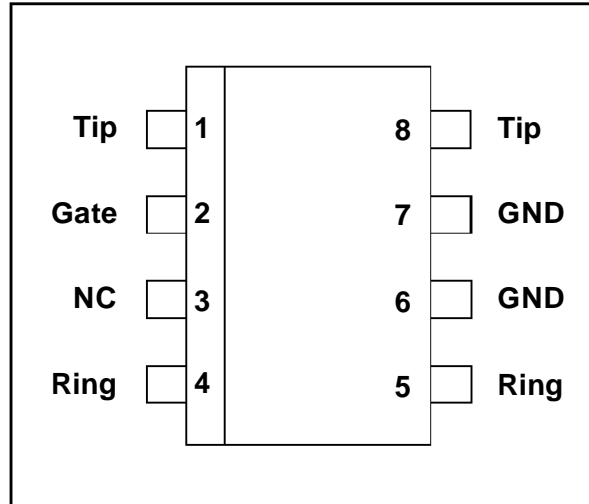


CONNECTION DIAGRAMS

DIL 8 Plastic



SO 8 Plastic



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